

1 Description

The iW673 is a high performance synchronous rectifier controller with an integrated MOSFET driver for flyback converters operating at discontinuous conduction mode. Combined with the MOSFET, the iW673 can emulate the diode rectifier at the secondary side of the flyback to reduce conduction loss. The iW673 determines the timing of the driver by sensing the voltage across the R_{DS(ON)} to achieve lossless sensing. The iW673 uses proprietary digital adaptive turn-off control technology to minimize the turn-off deadtime of the synchronous rectifier so that the parallel Schottky diode required by conventional synchronous rectifiers can be eliminated. The integrated driver has strong driving capability for high efficiency. The operating power consumption of the controller excluding the driver is less than 4mW at no load to achieve the ultra-low no-load power consumption at 5V output. The iW673 integrates a pulse linear regulator to maintain the operation of the synchronous rectifier at low system output voltage when the system is operating in constant current (CC) mode.

2 Features

- Digital adaptive turn-off control minimizes dead-time and eliminates the parallel Schottky diode
- Integrated pulse linear regulator (PLR) enables SR operation at down to 2.4V system output when system is in constant current (CC) mode with iW673-00, iW673-01, or iW673-20
- Wide V_{IN} pin operating voltage up to 25V (16V for iW673-00)
- Optimized 5V MOSFET gate driver Intelligent low power management achieves ultra-low no-load operating current
- Lossless MOSFET V_{DS} sensing for SR timing control
- 6-pin SOT23 package

3 Applications

 Compact AC/DC adapters/chargers for media tablets and smart phones

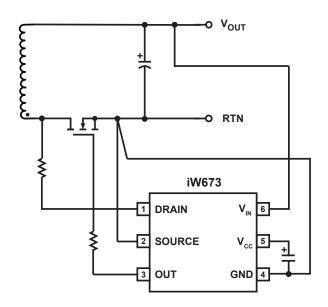


Figure 3.1: iW673 Typical Application Circuit

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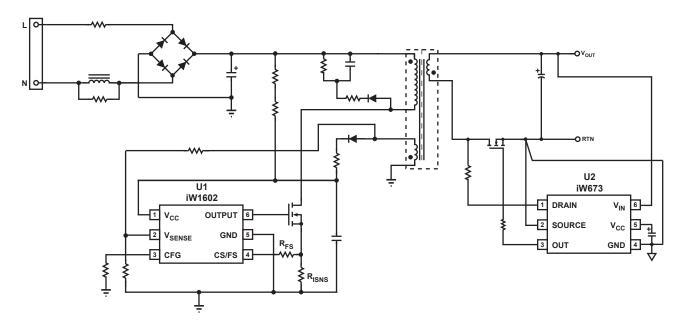


Figure 3.2: iW673 Typical Application Circuit Using iW1602 as the Primary-Side Controller (Achieving <75mW No-Load Power Consumption in 5V, 2.5A Adapter Designs with Fast Dynamic Load Response, and Supporting Constant Current Operation down to 2.4V System Output)

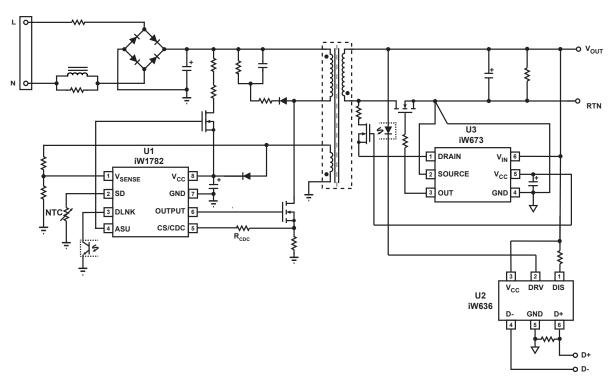


Figure 3.3 : iW673 Typical Application Circuit for Multi-Level Output Voltage and Current (Using iW1782 as Primary-Side Controller and iW636 as Secondary-Side Controller) for Qualcomm[®] Quick Charge™ 3.0 (Achieving <20mW No-Load Power Consumption)

Note: The DFET clamping circuit at the DRAIN pin of iW673 is not needed if the maximum voltage on the drain of the SR MOSFET is lower 60V.

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4 Pinout Description

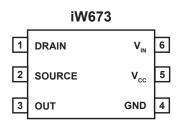


Figure 4.1: 6-Pin SOT23 Package

Pin No.	Pin Name	Туре	Pin Description
1	DRAIN	Analog Input	Synchronous rectifier MOSFET drain voltage sensing and the Pulse Linear Regulator (PLR) input.
2	SOURCE	Analog input	Synchrnous rectifier MOSFET source voltage sensing input.
3	OUT	Output	Synchronous rectifier MOSFET driver.
4	GND	Ground	Ground.
5	V _{cc}	Power Input	Output of internal LDO and PLR. It provides bias voltage for the internal logic circuit and the MOSFET driver. Connect this pin to a capacitor.
6	V _{IN}	Analog Input	Input of internal LDO and system output voltage sensing circuit. Connect to adapter/charger output for bias voltage. The internal LDO clamps the $V_{\rm CC}$ voltage at 5V when $V_{\rm IN}$ > 5V. The $V_{\rm IN}$ is also the input for the PLR enable comparator and the SR enable comparator.



5 Absolute Maximum Ratings

Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded.

Parameter	Symbol	Value	Units
V _{IN} DC supply voltage range (pin 6, I _{CC} = 15mA max)	V _{IN}	-0.3 to 33	V
Continuous DC supply current at V_{IN} pin (V_{IN} = 30V)	I _{vo}	15	mA
Continuous DC supply current at V_{CC} pin (V_{CC} = 5.5V)	I _{vcc}	15	mA
Gate peak output current	I _G	±3	А
DRAIN pin voltage (Note 1)	V _D	-1.5 to 60	V
DRAIN pin peak current	I _{DRAIN}	-40 to 300	mA
SOURCE pin voltage	V _{SOURCE}	- 0.6 to 1	V
V _{CC} pin voltage	V _{cc}	-0.6 to 6	V
Junction temperature	T _J	-40 to 150	°C
Storage temperature		–65 to 150	°C
Thermal resistance junction-to-ambient	θ_{JA}	190	°C/W
ESD rating per JEDEC JESD22-A114		2,000	V

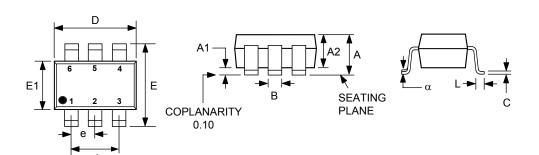
Notes:

Note 1: The DRAIN pin voltage should not be below -0.6V for more than 500 ns.



6 Physical Dimensions

6-Lead SOT Package



Symbol	Millimeters			
Syr	MIN	MAX		
Α	0.90	1.45		
A1	0.00	0.15		
A2	0.90	1.30		
В	0.30	0.50		
С	0.09	0.20		
D	2.80	3.00		
Ε	2.60	3.00		
E1	1.50	1.75		
е	0.95 BSC			
e1	1.90 BSC			
L	0.30	0.55		
α	0°	8°		

Compliant to JEDEC Standard MO-178AB

Controlling dimensions are in millimeters

This package is RoHS compliant and Halide free.

Soldering Temperature Resistance:

- [a] Package is IPC/JEDEC Std 020D Moisture Sensitivity Level 1
- [b] Package exceeds JEDEC Std No. 22-A111 for Solder Immersion Resistance; packages can withstand 10 s immersion < 260°C</p>

Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed $0.25\ \text{mm}$ per side.

The package top may be smaller than the package bottom. Dimensions D and E1 are are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs and interlead flash, but including any mismatch between top and bottom of the plastic body.

7 Ordering Information

Part no.	Options	Package	Description
iW673-00	V _{OUT} < 16V. I _{OUT} < 4A. Not recommended for new designs	SOT23	Tape & Reel ¹
iW673-01	$V_{\rm OUT}$ < 25V. $I_{\rm OUT}$ > 4A or when SR MOSFET with large package inductance (TO-220 or similar) is used.	SOT23	Tape & Reel ¹
iW673-10	$V_{\rm OUT}$ < 25V. $I_{\rm OUT}$ < 4A. PLR circuit is disabled until UVLO once $V_{\rm OUT}$ reaches PLR disable threshold ($V_{\rm LR_DISABLE}$).	SOT23	Tape & Reel ¹
iW673-20	V _{OUT} < 25V. I _{OUT} < 4A.	SOT23	Tape & Reel ¹

Note 1: Tape and reel packing quantity is 3,000/reel. Minimum ordering quantity is 3,000.



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Dialog Semiconductor complies to European Directive 2001/95/EC and from 2 January 2013 onwards to European Directive 2011/65/EU concerning Restriction of Hazardous Substances (RoHS/RoHS2).

Dialog Semiconductor's statement on RoHS can be found on the customer portal https://support.diasemi.com/. RoHS certificates from our suppliers are available on request.

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